

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Product No: MTMS1300NN24

Peak Emission Wavelength: 1300nm (3)

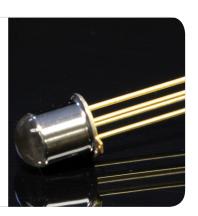
The MTMS1300NN24 is a multi-chip emitter designed for applications requiring same emission sources in a small, densely packaged area. These devices can be custom designed for specific wavelengths and outputs.

FEATURES

- > Hermetically Sealed Metal Can Pacakge
- > High Reliability
- > High Output Power

APPLICATIONS

- > Medical Instrumentation
- > Currency Validation
- > Biofluorescence Analysis



| Absolute Maximum Ratings (Ta=25°C) | | | | | Pb. • |
|------------------------------------|--------|------------|------|--|----------------|
| ITEMS | SYMBOL | RATINGS | UNIT | | lead-free ROMS |
| Forward Current (DC) | IF | 100 | mA | | |
| Forward Current (Pulse)*1 | IFP | 1 | Α | | |
| Reverse Voltage | VR | 5 | V | | |
| Power Dissipation | PD | 100 | mW | | |
| Operating Temperature Range | Topr | -20 ~ +85 | °C | | |
| Storage Temperature Range | Tstg | -30 ~ +100 | °C | | |
| Junction Temperature | Tj | 100 | °C | | |
| Lead Soldering Temperature*2 | Tls | 260 | °C | | |
| | | | | | |

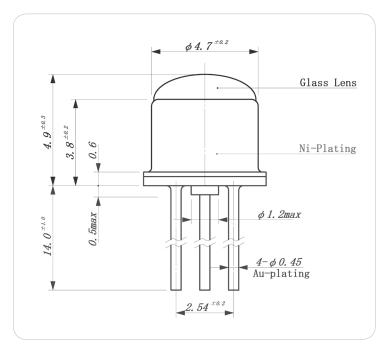
*1: Tw=10µsec, T=10msec. *2: Time 5 Sec max, Position: Up to 3mm from the body.

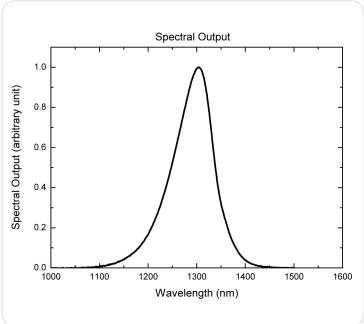
| Electrical | & Optical | Characteristics | (Ta = | 25°C)(Per | Chip) |
|------------|-----------|-----------------|-------|-----------|-------|
|------------|-----------|-----------------|-------|-----------|-------|

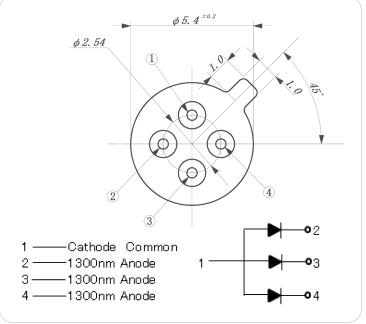
| ITEMS | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNIT |
|--------------------------|--------|------------|-----|------|-----|------|
| Power Output | PO | IF=50mA | | 0.9 | | mW |
| Forward Voltage | VF | IF=50mA | | 0.9 | | V |
| Reverse Current | IR | VR=5V | | | 100 | μΑ |
| Peak Emission Wavelength | λρ | IF=50mA | | 1300 | | nm |
| Spectral Line Half Width | Δλ | IF=50mA | | 70 | | nm |

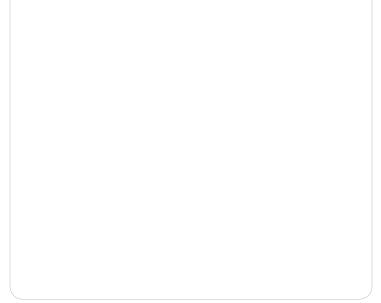
2014-01-14











Unit: mm, Tolerance: ±0.2

The information contained herein is subject to change without notice.

2014-01-14